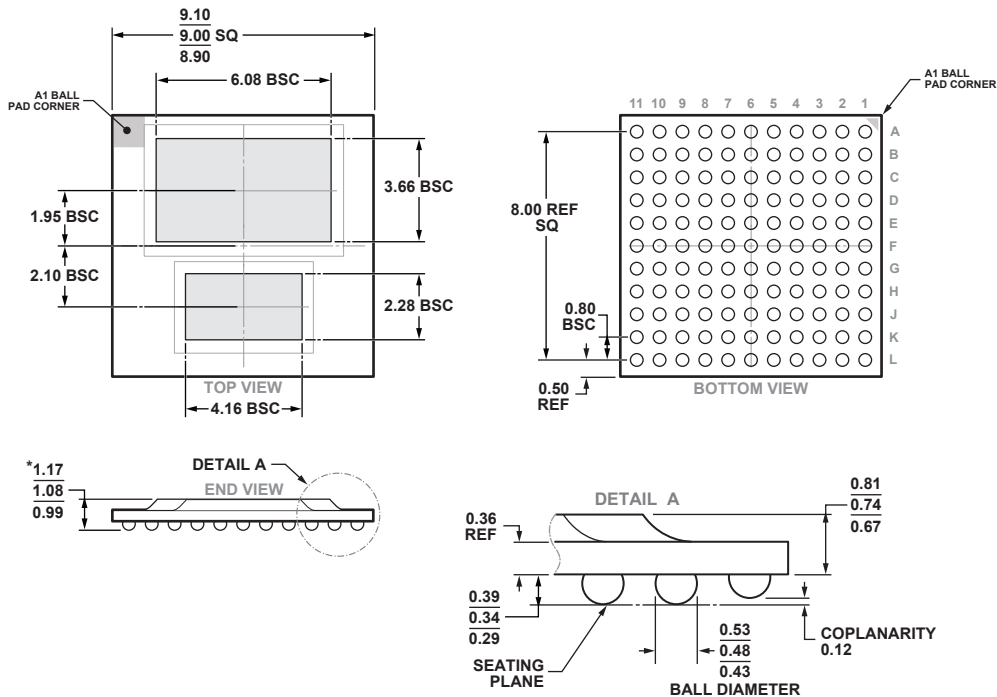


**121-Ball Chip Scale Package Ball Grid Array [CSP\_BGA]  
(BC-121-6)**

Dimensions shown in millimeters



\*COMPLIANT TO JEDEC STANDARDS MO-219 WITH  
EXCEPTION TO PACKAGE HEIGHT.